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# ON Semiconductor®

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## MPSA43

## **NPN High Voltage Amplifier**

- This device is designed for application as a video output to drive color CRT and other high voltage applications.
- Sourced from process 48.
- · See MPSA42 for characteristics.



1. Emitter 2. Base 3. Collector

# **Absolute Maximum Ratings \*** T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CES</sub>	Collector-Emitter Voltage	200	V
V <sub>CBO</sub>	Collector-Base Voltage	200	V
$V_{EBO}$	Emitter-Base Voltage	6.0	V
I <sub>C</sub>	Collector Current - Continuous	200	mA
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 ~ +150	°C

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- These ratings are based on a maximum junction temperature of 150 degrees C.
   These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

## Electrical Characteristics T<sub>A</sub>=25°C unless otherwise noted

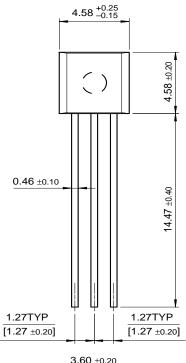
Symbol	Parameter	Test Condition	Min.	Max.	Units	
Off Charac	Off Characteristics					
V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage *	$I_C = 1.0 \text{mA}, I_B = 0$	200		V	
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_C = 100 \mu A, I_E = 0$	200		V	
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_C = 100 \mu A, I_C = 0$	6.0		V	
I <sub>CBO</sub>	Collector Cutoff Current	$V_{CB} = 160V, I_{E} = 0$		0.1	μА	
I <sub>EBO</sub>	Emitter Cutoff Current	$V_{EB} = 4.0V, I_{C} = 0$		0.1	μА	
On Characteristics *						
h <sub>FE</sub>	DC Current Gain	I <sub>C</sub> = 1.0mA, V <sub>CE</sub> = 10V	25			
		$I_C = 10 \text{mA}, V_{CE} = 10 \text{V}$	40			
		$I_C = 30 \text{mA}, V_{CE} = 10 \text{V}$	50	200		
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 20mA, I <sub>B</sub> = 2.0mA		0.4	V	
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	I <sub>C</sub> = 20mA, I <sub>B</sub> = 2.0mA		0.9	V	
Small Signal Characteristics *						
f <sub>T</sub>	Current Gain Dandwidth Product	$I_C = 10 \text{mA}, V_{CE} = 20 \text{V}, f = 100 \text{MHz}$	50		MHz	
C <sub>cb</sub>	Collector-Base Capacitance	$V_{CB} = 20V, I_E = 0, f = 1.0MHz$		4.0	pF	
Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2.0%						

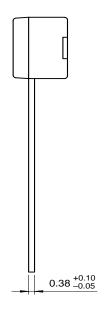
# Thermal Characteristics $T_A=25$ °C unless otherwise noted

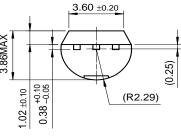
Symbol	Parameter	Max.	Units
P <sub>D</sub>	Total Device Dissipation	625	mW
	Derate above 25°C	5.0	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	°C/W

# **Package Dimensions**

TO-92







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